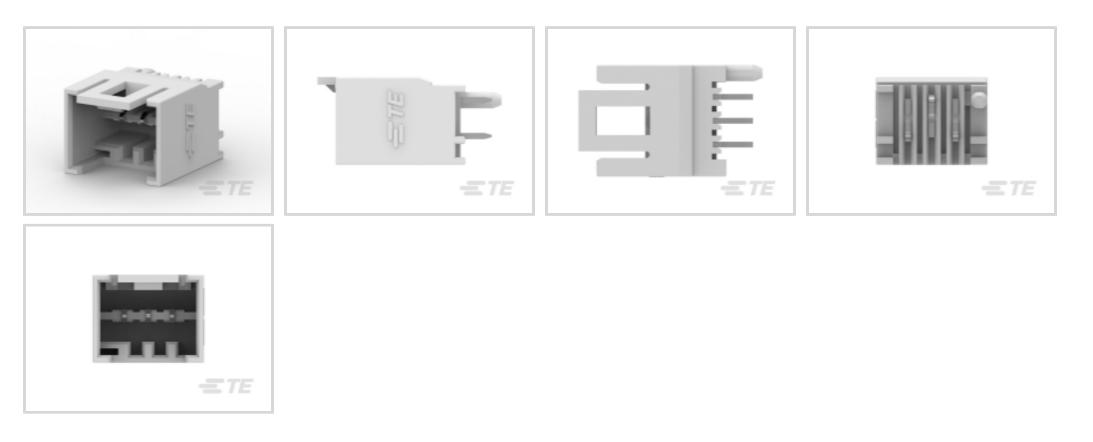
1-2232960-3 - ACTIVE

TE Internal #: 1-2232960-3 PCB Mount Header, Vertical, Wire-to-Board, 3 Position, 2.5 mm [. 098 in] Centerline, Fully Shrouded, Tin, Through Hole - Solder, Signal, Natural

View on TE.com >

connectivity

Connectors > PCB Connectors > PCB Headers & Receptacles



Connector System: Wire-to-Board

Number of Positions: 3

Number of Rows: 1

Centerline (Pitch): 2.5 mm [.098 in]

PCB Mount Orientation: Vertical

Features

Product Type Features

Connector System	Wire-to-Board
Header Type	Fully Shrouded
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
PCB Connector Assembly Type	PCB Mount Header
Configuration Features	
Number of Positions	3
Number of Rows	1
PCB Mount Orientation	Vertical
Electrical Characteristics	
Operating Voltage	50 VAC
Body Features	
Primary Product Color	Natural
Contact Features	

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Contact Layout	Inline, Staggered
PCB Contact Termination Area Plating Material Thickness	3.8 μm[149.6 μin]
Mating Tab Width	1.5 mm[.059 in]
Mating Tab Thickness	.6 mm[.024 in]
Contact Mating Area Plating Material Thickness	1.27 μm[50.8 μin]
PCB Contact Termination Area Plating Material Finish	Matte
Contact Shape & Form	Square
Contact Mating Area Plating Material Finish	Matte
Contact Underplating Material	Nickel
PCB Contact Termination Area Plating Material	Tin
Contact Base Material	Copper Alloy
Contact Mating Area Plating Material	Tin
Contact Type	Tab
Contact Current Rating (Max)	2 A
Termination Features	
Square Termination Post & Tail Dimension	.6 mm[.023 in]
Termination Post & Tail Length	2.9 mm[.11 in]
Termination Method to Printed Circuit Board	Through Hole - Solder

Mechanical Attachment

Mating Alignment Type Keye	
Mating Retention With	
PCB Mount Retention Type None	e
Mating Retention Type Latch	h
Connector Mounting Type Board	d Mount
Mating Alignment With	
PCB Mount Alignment With	
PCB Mount Retention With	out
Housing Features	
Housing Material PA 60	6 GF
Centerline (Pitch) 2.5 m	nm[.098 in]
Dimensions	
Connector Length 10.1	mm[.39 in]

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Connector Height	15.5 mm[.61 in]
Usage Conditions	
Housing Temperature Rating	Standard
Operating Temperature Range	-40 – 120 °C[-40 – 248 °F]
Operation/Application	
Solder Process Feature	Board Standoff
Circuit Application	Signal
Industry Standards	
Glow Wire Rating	Glow Wire
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Type	Box, Carton
Product Compliance For compliance documentation, visit the product page on TE.com>	
EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant

China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2022 (224) Candidate List Declared Against: JUNE 2022 (224) Does not contain REACH SVHC
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Capability	Not reviewed for solder process capability

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

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PCB Mount Header, Vertical, Wire-to-Board, 3 Position, 2.5 mm [.098 in] Centerline, Fully Shrouded, Tin, Through Hole - Solder, Signal, Natural



Compatible Parts



Documents

Product Drawings 3P POTTED RAST 2.5 HEADER

English

CAD Files 3D PDF

3D

Customer View Model ENG_CVM_CVM_1-2232960-3_B.2d_dxf.zip

English

Customer View Model ENG_CVM_CVM_1-2232960-3_B.3d_igs.zip

English

Customer View Model ENG_CVM_CVM_1-2232960-3_B.3d_stp.zip

English

By downloading the CAD file I accept and agree to the Terms and Conditions of use.

Product Specifications Product Specification

English

Product Environmental Compliance MD_1-2232960-3_03072018029_dmtec

English

MD_1-2232960-3_03072018029_dmtec

English